DATA SHEET

SKY73025-31: 2000 – 2700 MHz High Gain and Linearity Diversity Downconversion Mixer

Applications
- 2G/3G base station transceivers:
  - GSM/EDGE, CDMA, UMTS/WCDMA
- WiFi (802.11)
- WiMAX (802.16)
- 3GPP long-term evolution
- Land mobile radio
- Wireless Local Loop
- High performance radio links
- Private mobile radio

Features
- Operating frequency range: 2000 to 2700 MHz
- IF frequency range: 50 to 500 MHz
- Conversion gain: 9.6 dB @ 140 MHz IF
- IIP3: +25.4 dBm
- OIP3: +35 dBm
- Noise Figure: 10 dB
- Integrated LO drivers
- Integrated low loss RF baluns
- High linearity IF amplifiers
- On-chip SPDT LO switch (greater than 40 dB LO-to-LO isolation)
- Small, MCM (36-pin, 6 x 6 mm) Pb-free package (MSL3, 260 °C per JEDEC J-STD-020)

Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to Skyworks Definition of Green™, document number SQ04-0074.

Description
The SKY73025-31 is a fully integrated diversity mixer that includes Local Oscillator (LO) drivers, an LO switch, high linearity mixers, and large dynamic range Intermediate Frequency (IF) amplifiers. Low loss RF baluns have also been included to reduce design complications and lower system cost.

The SKY73025-31 features an input IP3 of +25.4 dBm and a Noise Figure (NF) of 10 dB, making the device an ideal solution for high dynamic range systems such as 2G/3G base station receivers. The LO switch provides more than 40 dB of isolation between LO inputs and supports the switching time required for GSM/EDGE base stations.

The SKY73025-31 is manufactured using a robust silicon BiCMOS process and has been designed for optimum long-term reliability. The SKY73025-31 diversity downconversion mixer is provided in a compact, 36-pin 6 x 6 mm Multi-Chip Module (MCM). A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

Figure 1. SKY73025-31 Block Diagram
Figure 2. SKY73025-31 Pinout – 36-Pin MCM (Top View)

Table 1. SKY73025-31 Signal Descriptions

<table>
<thead>
<tr>
<th>Pin #</th>
<th>Name</th>
<th>Description</th>
<th>Pin #</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>RFA</td>
<td>Channel A RF input</td>
<td>19</td>
<td>L01</td>
<td>Local oscillator 1 input</td>
</tr>
<tr>
<td>2</td>
<td>NC</td>
<td>No connect</td>
<td>20</td>
<td>GND</td>
<td>Ground</td>
</tr>
<tr>
<td>3</td>
<td>GND</td>
<td>Ground</td>
<td>21</td>
<td>VCC_LO</td>
<td>DC supply, +5 V</td>
</tr>
<tr>
<td>4</td>
<td>VCC_LO</td>
<td>DC supply, +5 V</td>
<td>22</td>
<td>GND</td>
<td>Ground</td>
</tr>
<tr>
<td>5</td>
<td>GND</td>
<td>Ground</td>
<td>23</td>
<td>LO_SEL</td>
<td>Local oscillator select switch control</td>
</tr>
<tr>
<td>6</td>
<td>VCC_LO</td>
<td>DC supply, +5 V</td>
<td>24</td>
<td>GND</td>
<td>Ground</td>
</tr>
<tr>
<td>7</td>
<td>GND</td>
<td>Ground</td>
<td>25</td>
<td>GND</td>
<td>Ground</td>
</tr>
<tr>
<td>8</td>
<td>NC</td>
<td>No connect</td>
<td>26</td>
<td>GND</td>
<td>Ground</td>
</tr>
<tr>
<td>9</td>
<td>RFB</td>
<td>Channel B RF input</td>
<td>27</td>
<td>L02</td>
<td>Local oscillator 2 input</td>
</tr>
<tr>
<td>10</td>
<td>VCC_RFB</td>
<td>Channel B RF DC supply, +5 V</td>
<td>28</td>
<td>NC</td>
<td>No connect</td>
</tr>
<tr>
<td>11</td>
<td>NC</td>
<td>No connect</td>
<td>29</td>
<td>RIFA</td>
<td>Channel A IF bias adjust</td>
</tr>
<tr>
<td>12</td>
<td>GND</td>
<td>Ground</td>
<td>30</td>
<td>VCC_IFA</td>
<td>Channel A IF DC supply, +5 V</td>
</tr>
<tr>
<td>13</td>
<td>IFB+</td>
<td>Positive channel B IF output</td>
<td>31</td>
<td>NC</td>
<td>No connect</td>
</tr>
<tr>
<td>14</td>
<td>IFB–</td>
<td>Negative channel B IF output</td>
<td>32</td>
<td>IFA+</td>
<td>Positive channel A IF output</td>
</tr>
<tr>
<td>15</td>
<td>NC</td>
<td>No connect</td>
<td>33</td>
<td>IFA–</td>
<td>Negative channel A IF output</td>
</tr>
<tr>
<td>16</td>
<td>VCC_IFB</td>
<td>Channel B IF DC supply, +5 V</td>
<td>34</td>
<td>GND</td>
<td>Ground</td>
</tr>
<tr>
<td>17</td>
<td>RIFB</td>
<td>Channel B IF bias adjust</td>
<td>35</td>
<td>NC</td>
<td>No connect</td>
</tr>
<tr>
<td>18</td>
<td>NC</td>
<td>No connect</td>
<td>36</td>
<td>VCC_RFA</td>
<td>Channel A RF DC supply, +5 V</td>
</tr>
</tbody>
</table>
Functional Description

The SKY73025-31 is a high gain diversity mixer, optimized for base station receiver applications. The device consists of two diversity channels (A and B), each consisting of a low loss RF balun, high linearity passive mixer, and a low noise IF amplifier.

Two LO amplifiers (independent of channels A and B) are also included that allow the SKY73025-31 to connect directly to the output of a Voltage Controlled Oscillator (VCO). This eliminates the extra gain stages needed by most discrete passive mixers. A Single Pole, Double Throw (SPDT) switch has been included to select between two different LO inputs for frequency hopping applications (i.e., GSM).

RF Baluns and Passive Mixer

The RF baluns provide a single ended input, which can easily be matched to $50\,\Omega$ using a simple external matching circuit. The RF baluns offer very low loss, and excellent amplitude and phase balance.

The high linearity SKY73025-31 is a passive, double balanced mixer that provides a very low conversion loss and an excellent 3rd Order Input Intercept Point (IIP3).

Additionally, the balanced nature of the mixer provides for high port-to-port isolation.

LO Buffers and SPDT LO Switch

The LO buffers allow the input power of the SKY73025-31 to be in the range of $\pm 6\,\text{dBm}$. The LO section is optimized for low-side LO injection. However, each of the two LOs can be driven over a wide frequency range with only slight degradation in performance.

A high isolation SPDT switch allows the SKY73025-31 to be used for frequency hopping applications. This switch provides greater than 45 dB of LO1 to LO2 isolation:

<table>
<thead>
<tr>
<th>LO_SEL Input</th>
<th>LO Path Selected</th>
</tr>
</thead>
<tbody>
<tr>
<td>High</td>
<td>LO1 (pin 19) enabled</td>
</tr>
<tr>
<td>Low</td>
<td>LO2 (pin 27) enabled</td>
</tr>
</tbody>
</table>

For applications that do not require frequency hopping, LO_SEL is fixed to one state and the appropriate LO input is used. An internal pull-down resistor enables the LO2 input.

IF Amplifier

The SKY73025-31 includes high dynamic range IF amplifiers that follow the passive mixers in the signal path. The outputs require a supply voltage connection using inductive chokes. These choke inductors should be high-Q and have the handle to handle 200 mA or greater.

A simple matching network allows the output ports to be matched to a balanced 200 $\Omega$ impedance. The IF amplifiers are optimized for IF frequencies between 50 and 500 MHz. The IF amplifiers can be operated outside of this range, but with a slight degradation in performance.

The RIFA and RIFB pins (29 and 17, respectively) can be connected to external resistors (R1 and R2 – see Figure 3) to reduce the IF amplifier bias current. When a resistor is connected to pin 29 (R2), the Channel A IF amplifier current is reduced. When a resistor is connected to pin 17 (R1), the Channel B IF amplifier current is reduced. The total amount of current reduced for Channel A and B IF amplifiers is the amount of mixer current that is reduced.

Table 2 shows the change in Channel A and/or B amplifier current from using either of three different external resistors.

For example, if a 10 k$\Omega$ resistor is used on pin 29 and a 5.1 k$\Omega$ resistor is used on pin 17, the Channel A IF amplifier current is reduced by 7 mA and the Channel B IF amplifier current is reduced by 14 mA. The total mixer current is reduced by 21 mA (7 mA + 14 mA).

Note that the use of any external resistors on either of these two pins also degrades IIP3 performance. Skyworks recommends using external resistors no smaller than 1 k$\Omega$.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY73025-31 are provided in Table 3 and the recommended operating conditions in Table 4. Electrical characteristics for the SKY73025-31 are provided in Tables 5 through 7.
Table 2. IF Amplifier Bias Current Adjustment

<table>
<thead>
<tr>
<th>External Resistor Connected to Pin 17 and/or Pin 29 (kΩ)</th>
<th>Channel A and/or Channel B IF Amplifier Bias Current Change (mA)</th>
</tr>
</thead>
<tbody>
<tr>
<td>No external resistor</td>
<td>0</td>
</tr>
<tr>
<td>10</td>
<td>−7</td>
</tr>
<tr>
<td>5.1</td>
<td>−14</td>
</tr>
<tr>
<td>2.2</td>
<td>−33</td>
</tr>
</tbody>
</table>

Note: The resistor values listed here were those tested. Other resistor values can be used with similar reductions in bias current.

Table 3. SKY73025-31 Absolute Maximum Ratings

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Minimum</th>
<th>Maximum</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Supply voltage, +5 V</td>
<td>VCC</td>
<td>4.5</td>
<td>5.5</td>
<td>V</td>
</tr>
<tr>
<td>Supply current</td>
<td>ICC</td>
<td>440</td>
<td></td>
<td>mA</td>
</tr>
<tr>
<td>RF input power</td>
<td>PRF</td>
<td>+20</td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>LO input power</td>
<td>PLO</td>
<td>+20</td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>Operating case temperature</td>
<td>TC</td>
<td>–40</td>
<td>+85</td>
<td>°C</td>
</tr>
<tr>
<td>Junction temperature</td>
<td>TJ</td>
<td></td>
<td>+150</td>
<td>°C</td>
</tr>
<tr>
<td>Storage case temperature</td>
<td>TSTG</td>
<td>–40</td>
<td>+150</td>
<td>°C</td>
</tr>
</tbody>
</table>

Notes: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value.

Nominal thermal resistance (junction to center ground pad) is 5.1 °C/W.

**CAUTION:** Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

Table 4. SKY73025-31 Recommended Operating Conditions

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Minimum</th>
<th>Typical</th>
<th>Maximum</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Supply voltage, +5 V (VCC1 – VCC7)</td>
<td>VCC</td>
<td>4.75</td>
<td>5.00</td>
<td>5.25</td>
<td>V</td>
</tr>
<tr>
<td>Supply current</td>
<td>ICC</td>
<td>390</td>
<td></td>
<td></td>
<td>mA</td>
</tr>
<tr>
<td>LO input power</td>
<td>PLO</td>
<td>–6</td>
<td>0</td>
<td>+6</td>
<td>dBm</td>
</tr>
<tr>
<td>LO select input: high low</td>
<td>LO_SELH, LO_SELl</td>
<td>2.2</td>
<td></td>
<td>0.8</td>
<td>V</td>
</tr>
<tr>
<td>Operating case temperature</td>
<td>TC</td>
<td>–40</td>
<td></td>
<td>+85</td>
<td>°C</td>
</tr>
<tr>
<td>RF frequency range</td>
<td>FRF</td>
<td>2000</td>
<td></td>
<td>2700</td>
<td>MHz</td>
</tr>
<tr>
<td>LO frequency range (Note 1)</td>
<td>FLO</td>
<td>1800</td>
<td></td>
<td>2600</td>
<td>MHz</td>
</tr>
<tr>
<td>IF frequency range</td>
<td>FF</td>
<td>50</td>
<td></td>
<td>500</td>
<td>MHz</td>
</tr>
</tbody>
</table>

Note 1: The SKY73025-31 has been optimized for low-side LO injection. However, the LO can be used outside of the specified frequency range (supported up to 2850 MHz) with degraded performance.
Table 5. SKY73025-31 Electrical Specifications (Note 1)
(Voltage Supply = +5 V, \( T_c = +25 \, ^\circ \text{C} \), LO = 0 dBm, RF Frequency = 2570 MHz, IF Frequency = 140 MHz, LO Frequency = 2430 MHz, Unless Otherwise Noted)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Test Condition</th>
<th>Min</th>
<th>Typical</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Conversion gain</td>
<td>G</td>
<td></td>
<td>8.0</td>
<td>9.6</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Noise Figure</td>
<td>NF</td>
<td></td>
<td></td>
<td>10</td>
<td>13</td>
<td>dB</td>
</tr>
<tr>
<td>Noise Figure with a blocker signal</td>
<td>NFBLK</td>
<td>Blocking signal input power = +8 dBm</td>
<td></td>
<td>25</td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>3rd Order Input Intercept Point</td>
<td>IIP3</td>
<td>( \text{FF} = 2530 , \text{MHz and 2530.8 MHz, } \text{Pr} = -10 , \text{dBm/tone} )</td>
<td>+22.0</td>
<td>+25.4</td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>3rd Order Output Intercept Point</td>
<td>OIP3</td>
<td>( \text{FF} = 2530 , \text{MHz and 2530.8 MHz, } \text{Pr} = -10 , \text{dBm/tone} )</td>
<td></td>
<td></td>
<td>+35</td>
<td>dBm</td>
</tr>
<tr>
<td>1 dB Input Compression Point</td>
<td>IP1dB</td>
<td></td>
<td></td>
<td>+14.2</td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>1 dB Output Compression Point</td>
<td>OP1dB</td>
<td></td>
<td></td>
<td>+22.8</td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>2RF – 2LO</td>
<td>2x2</td>
<td>( \text{Pr} = -10 , \text{dBm} )</td>
<td>–77</td>
<td>–57</td>
<td></td>
<td>dBc</td>
</tr>
<tr>
<td>3RF – 3LO</td>
<td>3x3</td>
<td>( \text{Pr} = -10 , \text{dBm} )</td>
<td>–83</td>
<td>–70</td>
<td></td>
<td>dBc</td>
</tr>
<tr>
<td>LO1-to-LO2 isolation</td>
<td></td>
<td></td>
<td>40</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Channel-to-channel isolation</td>
<td></td>
<td></td>
<td>41</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>RF-to IF-isolation</td>
<td></td>
<td></td>
<td>60</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>LO leakage:</td>
<td></td>
<td></td>
<td>–41</td>
<td>–53</td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>( \text{RF port} )</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>( \text{IF port} )</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>LO_SEL input</td>
<td></td>
<td></td>
<td>–20</td>
<td>150</td>
<td>250</td>
<td>μA</td>
</tr>
<tr>
<td>LO switching time</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>0.5</td>
<td>μs</td>
</tr>
<tr>
<td>RF port input return loss</td>
<td>( Z_{\text{IN, RF}} )</td>
<td>With external matching components</td>
<td>14</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>LO port input return loss</td>
<td>( Z_{\text{IN, LO}} )</td>
<td>With external matching components</td>
<td>14</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>IF port input return loss</td>
<td>( Z_{\text{OUT, IF}} )</td>
<td>With external matching components</td>
<td>14</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
</tbody>
</table>

Note 1: Performance is guaranteed only under the conditions listed in this Table.
Table 6. SKY73025-31 Electrical Specifications (Note 1)
(Voltage Supply = +5 V, TC = +25 °C, LO = 0 dBm, RF Frequency = 2335 MHz, IF Frequency = 140 MHz, LO Frequency = 2195 MHz, Unless Otherwise Noted)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Test Condition</th>
<th>Min</th>
<th>Typical</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Conversion gain</td>
<td>G</td>
<td></td>
<td>9.2</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Noise Figure</td>
<td>NF</td>
<td></td>
<td>10.5</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>3rd Order Input Intercept Point</td>
<td>IIP3</td>
<td></td>
<td>+26.7</td>
<td></td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>3rd Order Output Intercept Point</td>
<td>OIP3</td>
<td></td>
<td>+35.9</td>
<td></td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>1 dB Input Compression Point</td>
<td>IP1dB</td>
<td></td>
<td>+14.6</td>
<td></td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>1 dB Output Compression Point</td>
<td>OP1dB</td>
<td></td>
<td>+22.8</td>
<td></td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>2RF – 2LO</td>
<td>2x2</td>
<td>−75</td>
<td></td>
<td></td>
<td></td>
<td>dBc</td>
</tr>
<tr>
<td>3RF – 3LO</td>
<td>3x3</td>
<td>−82</td>
<td></td>
<td></td>
<td></td>
<td>dBc</td>
</tr>
<tr>
<td>LO1-to-LO2 isolation</td>
<td>Iso</td>
<td></td>
<td>40</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Channel-to-channel isolation</td>
<td>Iso</td>
<td></td>
<td>76</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>RF to IF isolation</td>
<td>Iso</td>
<td></td>
<td>57</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>LO leakage:</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>@ RF port</td>
<td>−29</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>@ IF port</td>
<td>−48</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td>dBm</td>
</tr>
</tbody>
</table>

Table 7. SKY73025-31 Electrical Specifications (Note 1)
(Voltage Supply = +5 V, TC = +25 °C, LO = 0 dBm, RF Frequency = 2655 MHz, IF Frequency = 140 MHz, LO Frequency = 2795 MHz, Unless Otherwise Noted)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Test Condition</th>
<th>Min</th>
<th>Typical</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Conversion gain</td>
<td>G</td>
<td></td>
<td>8.7</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>Noise Figure</td>
<td>NF</td>
<td></td>
<td>12.1</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>3rd Order Input Intercept Point</td>
<td>IIP3</td>
<td></td>
<td>+19.2</td>
<td></td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>3rd Order Output Intercept Point</td>
<td>OIP3</td>
<td></td>
<td>+27.9</td>
<td></td>
<td></td>
<td>dBm</td>
</tr>
<tr>
<td>1 dB Input Compression Point</td>
<td>IP1dB</td>
<td></td>
<td>+9.4</td>
<td></td>
<td></td>
<td>dBm</td>
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<tr>
<td>1 dB Output Compression Point</td>
<td>OP1dB</td>
<td></td>
<td>+17.1</td>
<td></td>
<td></td>
<td>dBm</td>
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<tr>
<td>2RF – 2LO</td>
<td>2x2</td>
<td>−60.5</td>
<td></td>
<td></td>
<td></td>
<td>dBc</td>
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<tr>
<td>3RF – 3LO</td>
<td>3x3</td>
<td>−72</td>
<td></td>
<td></td>
<td></td>
<td>dBc</td>
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<tr>
<td>LO1-to-LO2 isolation</td>
<td>Iso</td>
<td></td>
<td>40</td>
<td></td>
<td></td>
<td>dB</td>
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<tr>
<td>Channel-to-channel isolation</td>
<td>Iso</td>
<td></td>
<td>48</td>
<td></td>
<td></td>
<td>dB</td>
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<tr>
<td>RF to IF isolation</td>
<td>Iso</td>
<td></td>
<td>61</td>
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<td>LO leakage:</td>
<td></td>
<td></td>
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<td></td>
<td></td>
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<tr>
<td>@ RF port</td>
<td>−40.1</td>
<td></td>
<td></td>
<td></td>
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<td>dBm</td>
</tr>
<tr>
<td>@ IF port</td>
<td>−67.7</td>
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<td></td>
<td></td>
<td></td>
<td>dBm</td>
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</table>
Application Circuit Design Considerations

RF Input and IF Output Matching
For best performance, RF and IF matching circuits are needed either for a differential output application or for a single-ended output application.
The 200 differential IF output impedance could be used to connect to a differential input Surface Acoustic Wave (SAW) filter or Variable Gain Amplifier (VGA). A 4:1 balun transformer could also be used to match the impedance to 50 for a single-ended output application.
As noted in Figure 5, components C2, C3, C6, C7, L2, and L4 are RF matching components; C16, C28, L8, and L13 are IF matching components; T1 and T2 are 4:1 IF baluns.

IF Bias Resistor
Components R1 and R2 (see Figure 5) are for the IF amplifier bias current adjustment. To operate the SKY73025-31 as specified in Tables 4 through 7, these resistors are not required.

PCB Layout
The following design considerations are general in nature and must be followed regardless of final use or configuration.
1. Paths to ground should be made as short and as low impedance as possible.
2. The ground pad of the SKY73025-31 provides critical electrical and thermal functionality. This pad is the main thermal conduit for heat dissipation. Since the circuit board acts as the heat sink, it must shunt as much heat as possible from the device. Therefore, design the connection to the ground pad to dissipate the maximum heat produced by the circuit board. For more information on soldering the SKY73025-31, refer to the Package and Handling Information section of this Data Sheet.

DC Power Supply
1. Skyworks recommends including external bypass capacitors on the VCC voltage inputs of the device. Place the bypass capacitors close to the VCC supply pins.
2. Components L5, L6, L14, and L15 (see Figure 5) are high-Q, low loss inductors. These inductors must be able to pass currents in excess of 200 mA DC.

Evaluation Board Description
The SKY73025-31 Evaluation Board is used to test the performance of the SKY73025-31 downconversion mixer. An assembly drawing for the Evaluation Board is shown in Figure 3 and the layer detail is provided in Figure 4. A schematic diagram for the SKY73025-31 Evaluation Board is shown in Figure 5.
Figure 3. SKY73025-31 Evaluation Board Assembly Diagram
Figure 4. SKY73025-31 Evaluation Board Layer Detail
RF Matching Circuits:

<table>
<thead>
<tr>
<th></th>
<th>C2</th>
<th>C3</th>
<th>C6</th>
<th>C7</th>
<th>L2</th>
<th>L4</th>
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<tbody>
<tr>
<td>2330 MHz</td>
<td>2 pF</td>
<td>0.5 pF</td>
<td>2 pF</td>
<td>0.4 pF</td>
<td>3.3 nH</td>
<td>3.3 nH</td>
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<td>2530 MHz</td>
<td>1.8 pF</td>
<td>0.6 pF</td>
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<td>0.6 pF</td>
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<td>2.2 nH</td>
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<tr>
<td>2620 ~ 2690 MHz</td>
<td>1.6 pF</td>
<td>0.6 pF</td>
<td>1.5 pF</td>
<td>0.6 pF</td>
<td>2.2 nH</td>
<td>2.2 nH</td>
</tr>
</tbody>
</table>

Note: The SKY73025-31 Evaluation Board can be converted to provide a differential output by removing components T1, T2, R3, and R4.

Some component labels may be different than the corresponding component symbol shown here. Component values, however, are accurate as of the date of this Data Sheet.

Figure 5. SKY73025-31 Evaluation Board Schematic
Package Dimensions
The PCB footprint for the SKY73025-31 is provided in Figure 6. Figure 7 shows the package dimensions for the 36-pin MCM, and Figure 8 provides the tape and reel dimensions.

Package and Handling Information
Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

THE SKY73025-31 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, PCB Design & SMT Assembly/Rework Guidelines for MCM-L Packages, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.
Figure 6. PCB Layout Footprint for the SKY73025-31 6 x 6 mm MCM

Note: The cross-hatched area represents the merger of the center ground pad +9 individual I/O ground pads. All I/O ground pads should have at least one via connected to internal ground planes for optimum electrical performance.

Thermal Via Array. φ0.3 mm on 0.6 mm pitch. Additional via in common ground pad will improve thermal and electrical performance. NOTE: thermal vias should be tented and filled with solder mask, 30-35 μm Cu plating recommended.
All measurements are in millimeters.

Pads are solder mask defined on one edge and metal defined on three edges.

Dimensioning and tolerancing according to ASME Y14.5M-1994.

Figure 7. SKY73025-31 36-Pin MCM Package Dimensions
Notes:
1. Carrier tape: black conductive polystyrene
2. Cover tape material: transparent conductive PSA
3. Cover tape size: 9.3 mm width
4. ESD surface resistivity is ≤1 x 10¹⁰ Ohms/square per EIA, JEDEC tape and reel specification.
5. Po/P1 10 pitches cumulative tolerance on tape: ±0.20 mm
6. Ao and Bo measurement point to be 0.30 mm from bottom of pocket
7. All dimensions are in millimeters
8. Pin 1 orientation is in top left corner for the following Skyworks products:
   SKY73022-21, -31
   SKY73023-21, -31
   For all other 6 x 6 mm MCM/RFLGA products, pin 1 orientation is in top right corner.

Figure 8. SKY73025-31 Tape and Reel Dimensions
### Ordering Information

<table>
<thead>
<tr>
<th>Model Name</th>
<th>Manufacturing Part Number</th>
<th>Evaluation Board Part Number</th>
</tr>
</thead>
<tbody>
<tr>
<td>SKY73025-31 Downconversion Mixer</td>
<td>SKY73025-31</td>
<td>TW19-D610</td>
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</tbody>
</table>

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